



## DESCRIPTION

The AM2305 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density. Advanced trench technology to provide excellent  $R_{DS(ON)}$ .

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, and low in-line power loss are needed in a very small outline surface mount package.

AM2305 is available in a SOT-23 package.

## ORDERING INFORMATION

Package Type	Part Number	
SOT-23	E3	AM2305E3R
		AM2305E3VR
Note	R: Tape & Reel V: Green Package	
AiT provides all Pb free products Suffix " V " means Green Package		

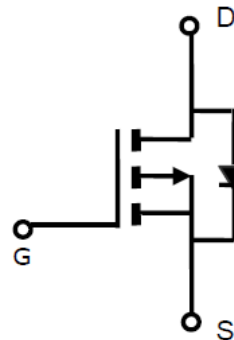
## FEATURES

- -30V/-4A,  $R_{DS(ON)} = 55m\Omega @ V_{GS} = -10V$
- -30V/-3A,  $R_{DS(ON)} = 64m\Omega @ V_{GS} = -4.5V$
- -30V/-2A,  $R_{DS(ON)} = 85m\Omega @ V_{GS} = -2.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and Maximum DC current capability
- Available in a SOT-23 package.

## APPLICATION

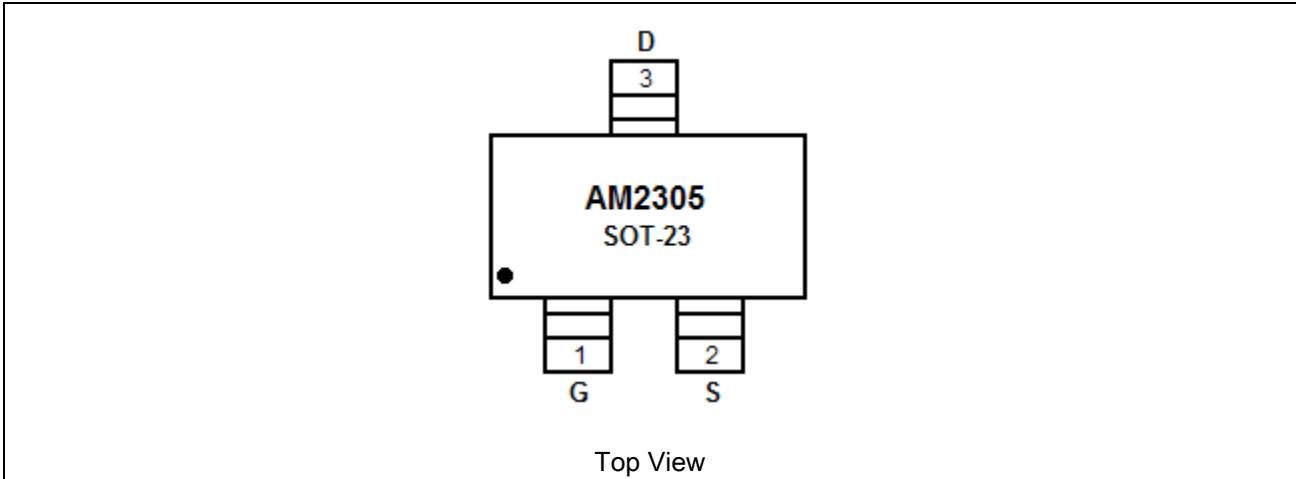
- High Frequency Point-of-Load Synchronous
- New working DC-DC Power System
- Load Switch

## P CHANNEL MOSFET





## PIN DESCRIPTION



Pin #	Symbol	Function
1	G	Gate
2	S	Source
3	D	Drain



## ABSOLUTE MAXIMUM RATINGS

T<sub>A</sub> = 25°C Unless otherwise specified

V <sub>DSS</sub> , Drain-Source Voltage		-30V
V <sub>GSS</sub> , Gate-Source Voltage		±12V
I <sub>D</sub> , Continuous Drain Current, V <sub>GS</sub> =10V <sup>NOTEA</sup>	T <sub>A</sub> =25°C	-4A
I <sub>DM</sub> , Pulsed Drain Current <sup>NOTEB</sup>		-12A
P <sub>D</sub> , Power Dissipation		
	T <sub>A</sub> =25°C	1.25W
	T <sub>A</sub> =70°C	0.8W
T <sub>J</sub> , Operation Junction Temperature		-55/150°C
T <sub>STG</sub> , Storage Temperature Range		-55/150°C

Stress beyond above listed "Absolute Maximum Ratings" may lead permanent damage to the device. These are stress ratings only and operations of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

NOTEA: The value of R<sub>θJA</sub> is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C.

NOTEB: The data tested by pulsed, pulse width ≤ 300us , duty cycle ≤ 2%

## THERMAL DATA

Parameter	Symbol	Max	Unit
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	120	°C/W
Thermal Resistance-Junction to Case	R <sub>θJC</sub>	65	°C/W



## ELECTRICAL CHARACTERISTICS

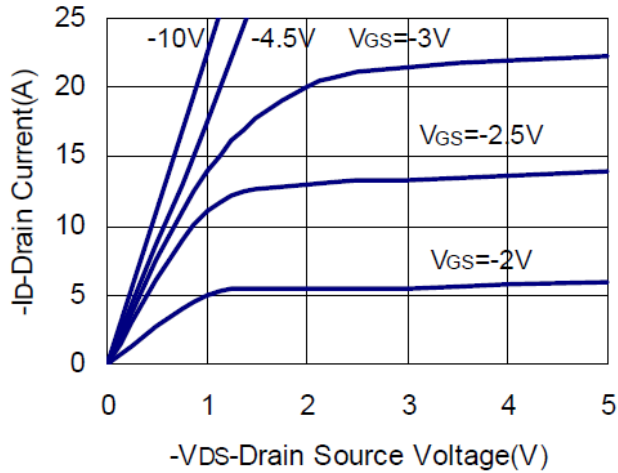
T<sub>A</sub> = 25°C Unless otherwise specified

Parameter	Symbol	Conditions	Min	Typ.	Max	Units
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	-20	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.6	-	-1.2	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V	-	-	±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V	-	-	-1	μA
		V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C	-	-	-10	
Drain-source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-4.0A	-	55	58	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3.0A	-	64	68	
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.0A	-	85	95	
Forward Transconductance	G <sub>fs</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-4.0A	-	10	-	S
<b>Source-Drain Diode</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.0A, V <sub>GS</sub> =0V	-	-0.7	-1.0	V
<b>Dynamic Parameters</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-15V	-	7	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> =-10V	-	13	-	
Gate-Drain Charge	Q <sub>gd</sub>	I <sub>D</sub> =-4.0A	-	1.8	-	
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =-15V V <sub>GS</sub> =0V f=1MHz	-	680	-	pF
Output Capacitance	C <sub>OSS</sub>		-	320	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>		-	65	-	
Turn-On Time	t <sub>d(ON)</sub>	V <sub>DD</sub> =-15V	-	12	18	ns
	T <sub>r</sub>	R <sub>L</sub> =15Ω	-	3	7	
Turn-Off Time	t <sub>d(OFF)</sub>	I <sub>D</sub> =-1A	-	34	42	
	T <sub>f</sub>	V <sub>GEN</sub> =-10V R <sub>G</sub> =6Ω	-	3	7	

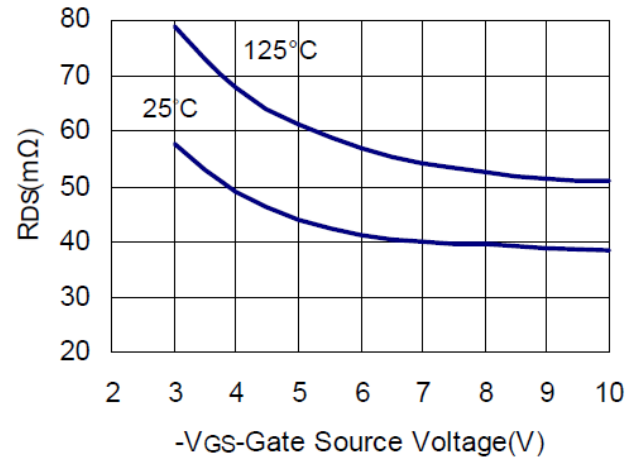


## TYPICAL CHARACTERISTICS

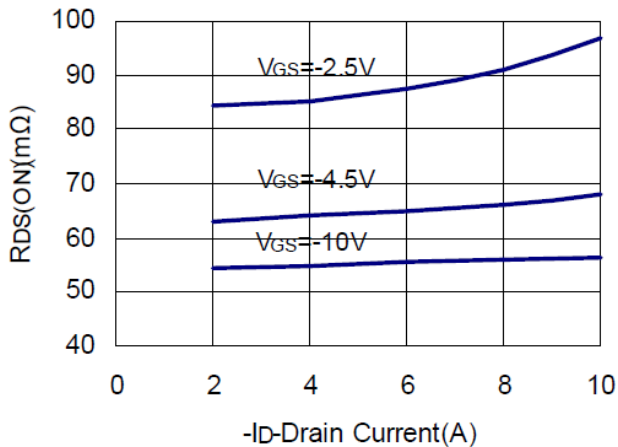
1. Output Characteristics



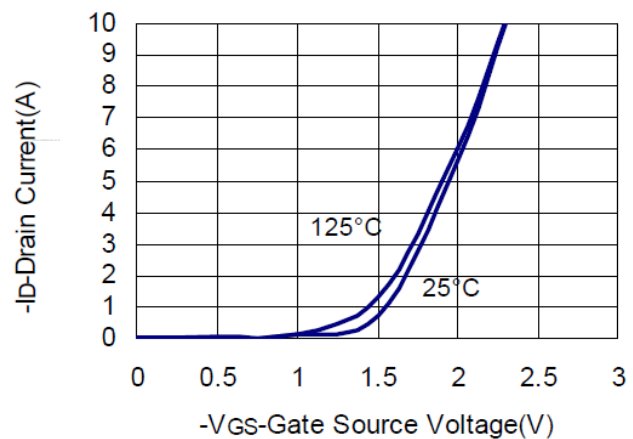
2. Drain-Source On Resistance



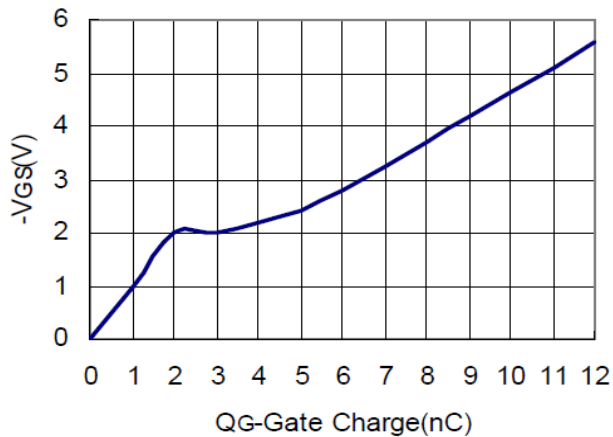
3. Drain Source On Resistance



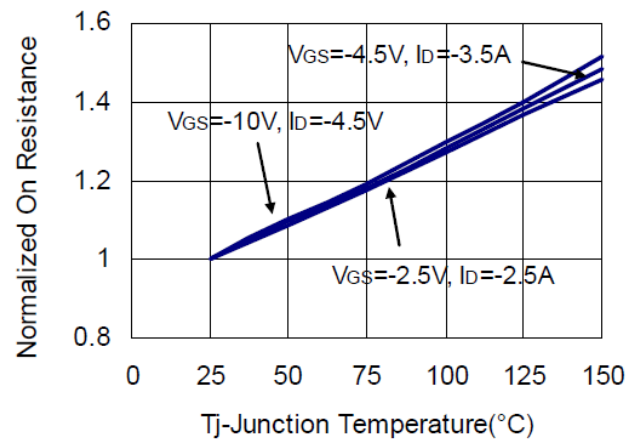
4. Transfer Characteristics



5. Gate Charge

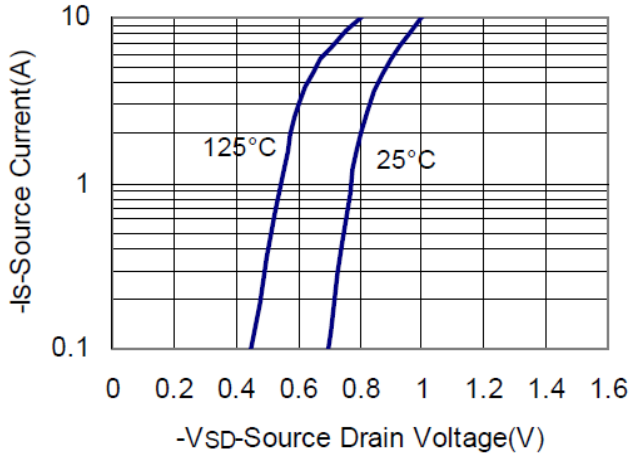


6. Drain Source Resistance

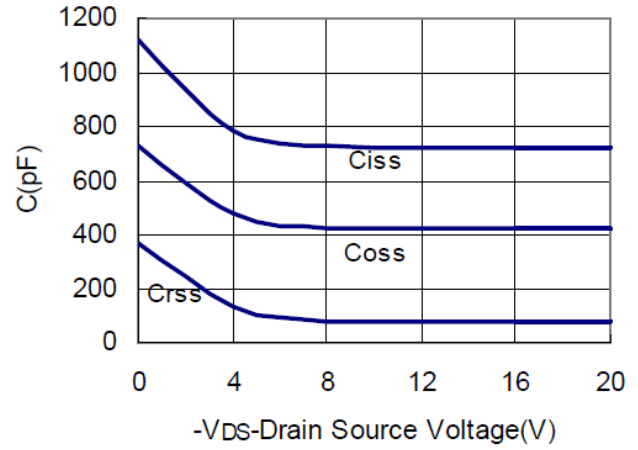




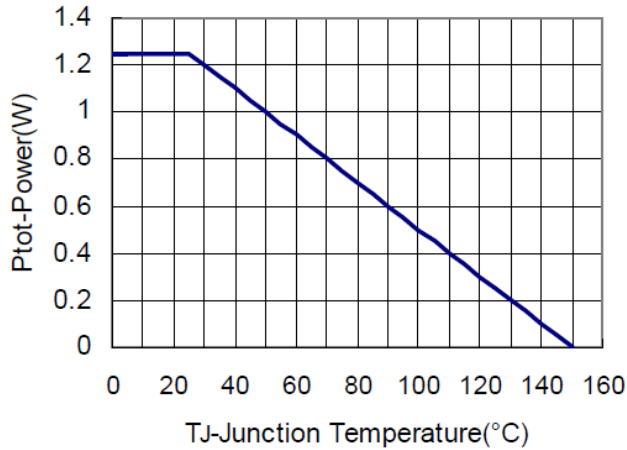
7. Source Drain Diode Forward



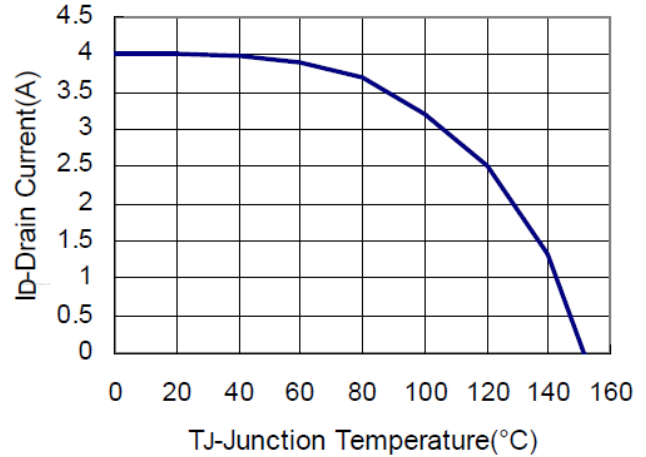
8. Capacitance



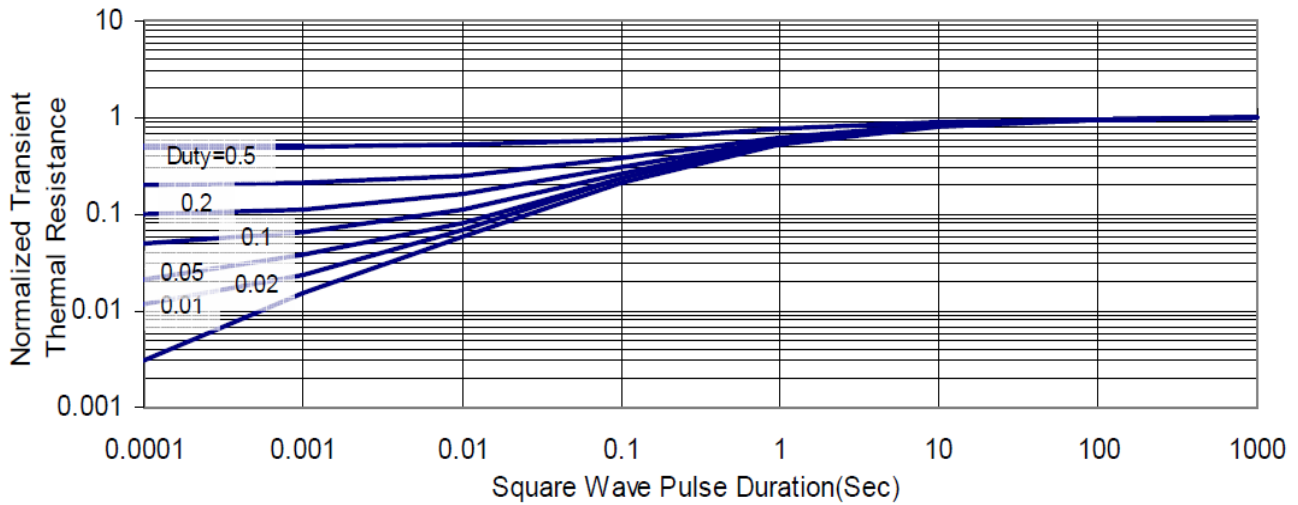
9. Power Dissipation



10. Drain Current



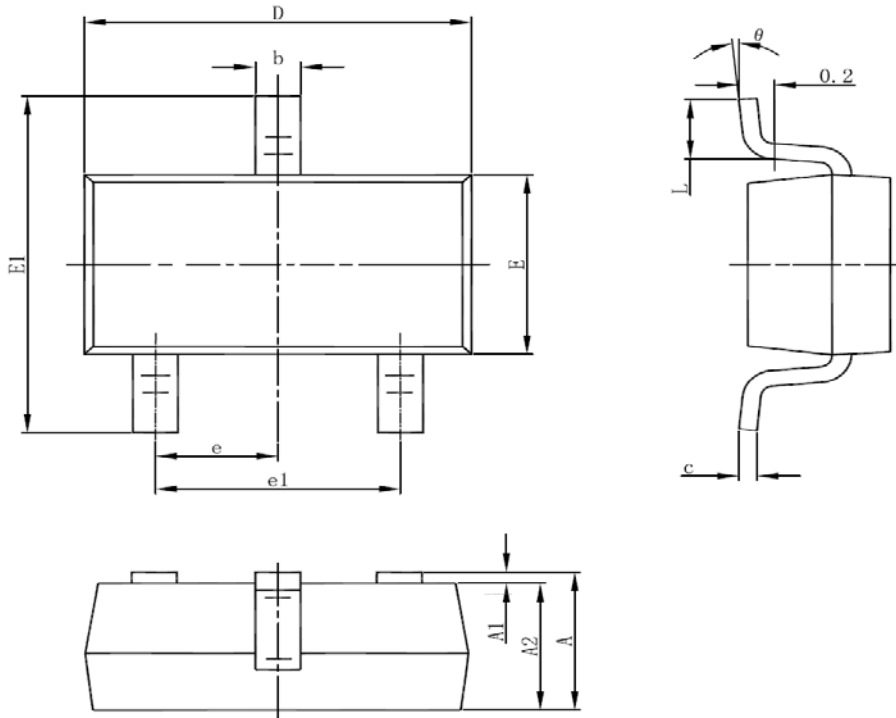
11. Thermal Transient Impedance





**PACKAGE INFORMATION**

Dimension in SOT-23 Package (Unit: mm)



SYMBOL	MIN	MAX
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950(BSC)	
e1	1.800	2.000
L	0.300	0.600
$\theta$	0°	8°



## IMPORTANT NOTICE

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